

UNISONIC TECHNOLOGIES CO., LTD

F2N65-TC **Power MOSFET**

2.0A, 650V N-CHANNEL POWER MOSFET

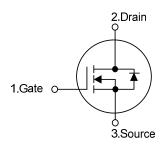
DESCRIPTION

The UTC F2N65-TC is a N-Channel enhancement mode silicon gate power MOSFET with Fast Body Diode. is designed high voltage, high speed power switching applications such. such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics.

FEATURES

- * $R_{DS(ON)} \le 4.8 \Omega @ V_{GS} = 10V, I_D = 1.0A$
- * Fast body diode MOSFET technology
- * Low switching losses due to reduced Qrr
- * Single Pulse Avalanche Energy Rated
- * Fast Switching Speeds
- * Linear Transfer Characteristics
- * High Input Impedance
- * Avalanche energy tested

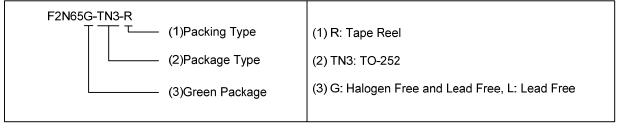
SYMBOL



ORDERING INFORMATION

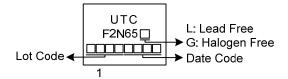
Ordering Number			Dooksaya	Pin Assignment			Dealing
Lead Free		Halogen Free	Package	1	2	3	Packing
F2N	65L-TN3-R	F2N65G-TN3-R	TO-252	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



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MARKING



F2N65-TC Power MOSFET

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage	V_{DSS}	650	>	
Gate-Source Voltage	V_{GSS}	±30	V	
Continuous Drain Current	I_{D}	2	Α	
Pulsed Drain Current (Note 2)	I_{DM}	4	Α	
Avalanche Energy Single Pulsed (Note 3)	E _{AS}	60	mJ	
Peak Diode Recovery dv/dt (Note 4)	dv/dt	6	V/ns	
Power Dissipation	P_D	46	W	
Junction Temperature	T_J	+150	°C	
Storage Temperature	T_{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 2.0A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 2.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATING	UNIT	
Junction to Ambient	θ_{JA}	110	°C/W	
Junction to Case	$\theta_{ m JC}$	2.71 (Note)	°C/W	

Note: Device mounted on FR-4 substrate Pc board, 2oz copper, with 1inch square copper plate.

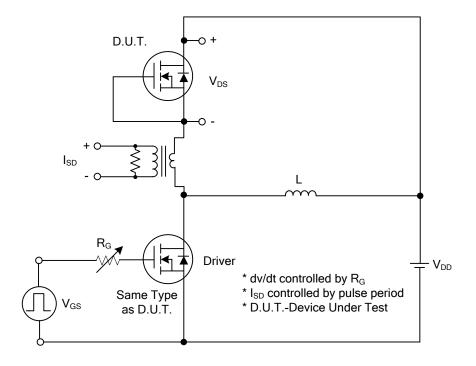
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT			
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	650			V		
Drain-Source Leakage Current	I_{DSS}	V _{DS} =650V, V _{GS} =0V			10	μΑ			
Cata Cauras Laglages Current	Forward	I _{GSS}	V _{GS} =30V, V _{DS} =0V			100	nA		
Gate- Source Leakage Current	Reverse		V_{GS} =-30V, V_{DS} =0V			-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	2.0		4.0	V			
Static Drain-Source On-State Resi	R _{DS(ON)}	V _{GS} =10V, I _D =1.0A			4.8	Ω			
DYNAMIC CHARACTERISTICS									
Input Capacitance		C _{ISS}			338		pF		
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		33		pF		
Reverse Transfer Capacitance	C_{RSS}			2.3		pF			
SWITCHING CHARACTERISTICS									
Total Gate Charge (Note 1)	Q_G	\/ -520\/ \/ -10\/ -2.0\		11		nC			
Gate-Source Charge		Q_GS	V_{DS} =520V, V_{GS} =10V, I_{D} =2.0A		4		nC		
Gate-Drain Charge		Q_GD	IG-IIIA (Note 1, 2)		0.9		nC		
Turn-On Delay Time (Note 1)		t _{D(ON)}			5		Ns		
Turn-On Rise Time		t _R	V _{DS} =100V, V _{GS} =10V, I _D =2.0A		16		Ns		
Turn-Off Delay Time		t _{D(OFF)}	R _G =25Ω (Note 1, 2)		20		Ns		
Turn-Off Fall Time	t_{F}	26				Ns			
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS									
Drain-Source Diode Forward Volta	V_{SD}	I _S =2.0A , V _{GS} =0V			1.4	V			
Reverse Recovery Time (Note 1)	t _{rr}	I _S =2.0A , V _{GS} =0V		98		ns			
Reverse Recovery Charge	Q_{rr}	di/dt=100A/μs		193		nC			

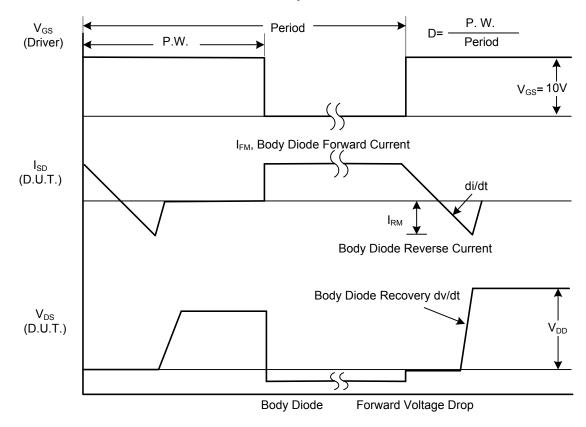
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



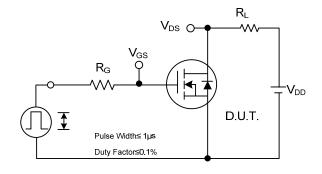
Peak Diode Recovery dv/dt Test Circuit

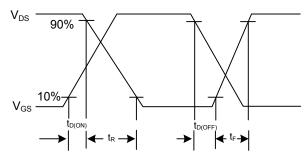


Peak Diode Recovery dv/dt Waveforms

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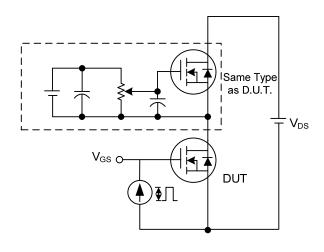
■ TEST CIRCUITS AND WAVEFORMS

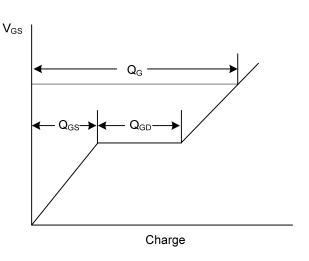




Switching Test Circuit

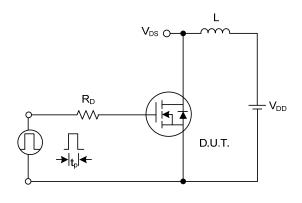
Switching Waveforms

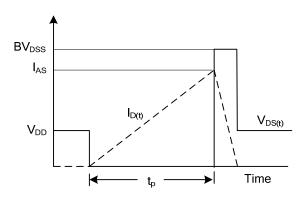




Gate Charge Test Circuit

Gate Charge Waveform

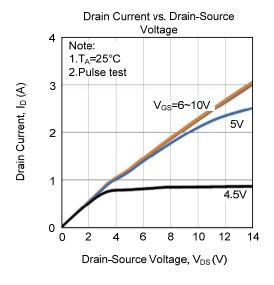


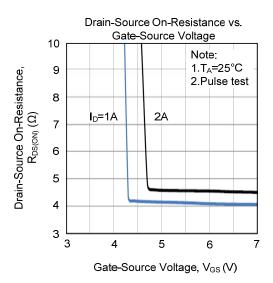


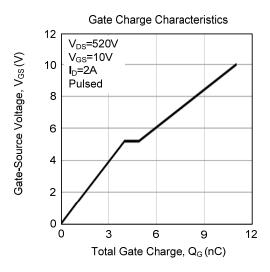
Unclamped Inductive Switching Test Circuit

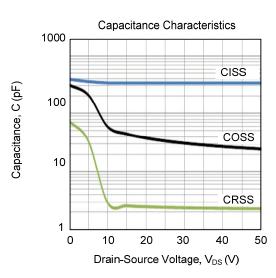
Unclamped Inductive Switching Waveforms

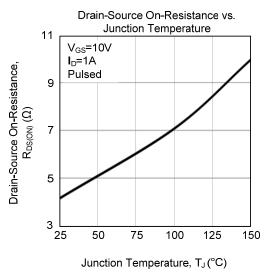
■ TYPICAL CHARACTERISTICS

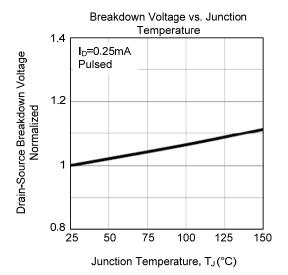




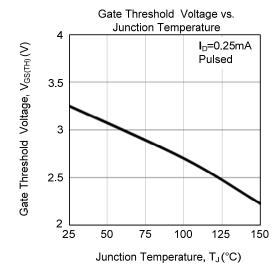


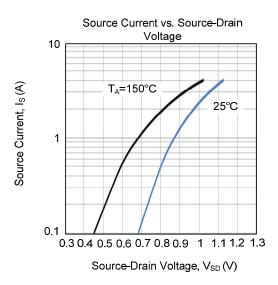


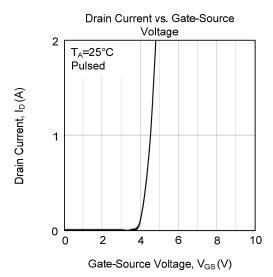


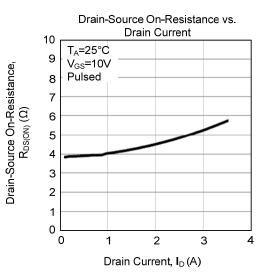


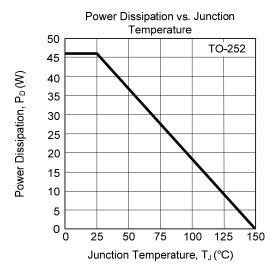
■ TYPICAL CHARACTERISTICS (Cont.)

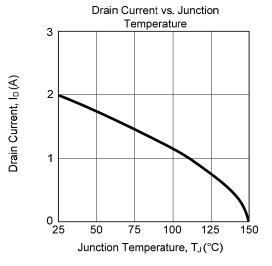




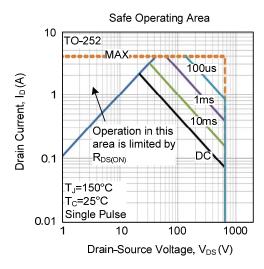








■ TYPICAL CHARACTERISTICS (Cont.)



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